

**RECEIVED  
CENTRAL FAX CENTER****MAR 13 2007****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Liu

Application No.: 10/634,964

Filed: 8/5/2003

Title: CHEMICAL MECHANICAL  
PLANARIZATION COMPOSITIONS FOR  
REDUCING EROSION IN SEMICONDUCTOR  
WAFERSArt Unit:  
1765Examiner:  
Patricia A. George

Attorney Docket No.: 02039US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**RESPONSE AFTER FINAL REJECTION**

Dear Sir:

In response to the Office Action of February 5, 2007, having a shortened statutory  
deadline of May 5, 2007, please amend the specification as follows.

PLEASE  
ENTER  
8/27/07  
[Signature]